

COMPLEMENTARY SILICON POWER TRANSISTORS

- STMicroelectronics PREFERRED SALESTYPES
- COMPLEMENTARY PNP NPN DEVICES
- FULLY MOLDED ISOLATED PACKAGE
- 2000 V DC ISOLATION (U.L. COMPLIANT)

APPLICATIONS

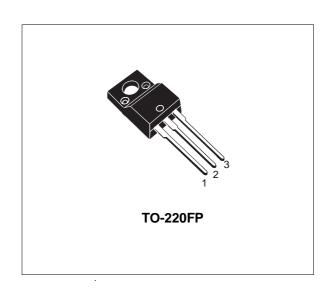
- GENERAL PURPOSE SWITCHING
- GENERAL PURPOSE AMPLIFIERS

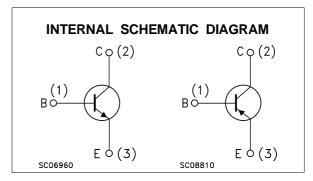
DESCRIPTION

The BD241BFP is silicon epitaxial-base NPN transistors mounted in TO-220FP fully molded isolated package.

It is inteded for power linear and switching applications.

The complementary PNP types is the BD242BFP.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value		Unit	
		NPN	BD241BFP		
		PNP	BD242BFP		
V _{CER}	Collector-Base Voltage ($R_{BE} = 100 \Omega$)	90	V		
V _{CEO}	Collector-Emitter Voltage (I _B = 0)		80	V	
V_{EBO}	Emitter-Base Voltage (I _C = 0)		5	V	
Ic	Collector Current		3	А	
I _{CM}	Collector Peak Current		5	А	
I _B	Base Current		1	А	
Ptot	Total Dissipation at T _c ≤ 25 °C		24	W	
T _{stg}	Storage Temperature		-65 to 150	°C	
Tj	Max. Operating Junction Temperature		150	°C	

For PNP types voltage and current values are negative.

February 2001

BD241BFP/BD242BFP

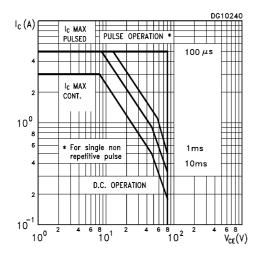
THERMAL DATA

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{CEO}	Collector Cut-off Current (I _B = 0)	V _{CE} = 60 V			0.3	mA
I _{CES}	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = 80 V			0.2	mA
I _{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = 5 V			1	mA
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage (I _B = 0)	Ic = 30 mA	80			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 3 A I _B = 0.6 A			1.2	V
V _{BE(ON)} *	Base-Emitter Voltage	I _C = 3 A V _{CE} = 4 V			1.8	V
h _{FE} ∗	DC Current Gain	I _C = 1 A	25 10			

^{*} Pulsed: Pulse duration = $300 \,\mu s$, duty cycle $\leq 2 \,\%$ For PNP types voltage and current values are negative.

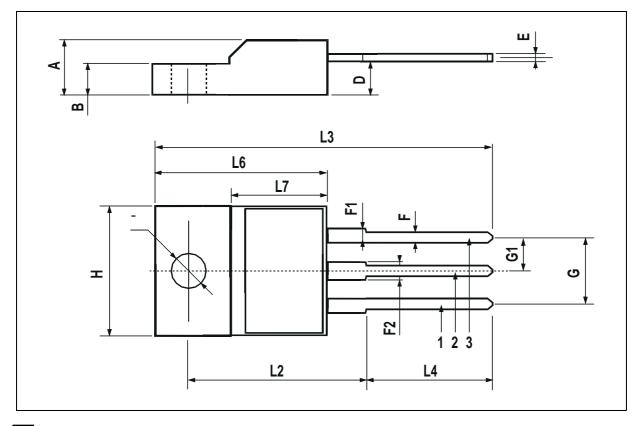
Safe Operating Area



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TO-220FP MECHANICAL DATA

DIM.	mm		inch			
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
Н	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	0.385		0.417
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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